

LP3944 RGB/White/Blue 8-LED Fun Light Driver

Check for Samples: LP3944

FEATURES

- Internal Power-on Reset
- Active Low Reset
- Internal Precision Oscillator
- Variable Dim Rates (from 6.25 ms to 1.6s; 160 Hz–0.625 Hz)

APPLICATIONS

- Customized Flashing LED Lights for Cellular Phones
- Portable Applications
- Digital Cameras
- Indicator Lamps
- General Purpose I/O Expander
- Toys

KEY SPECIFICATIONS

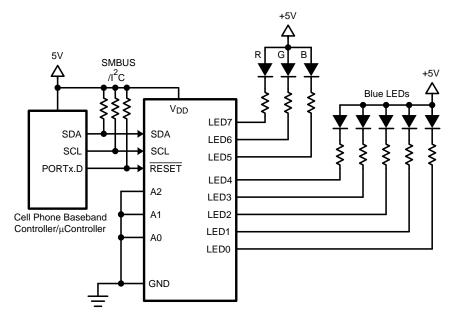
- 8 LED Driver (Multiple Programmable States—On, Off, Input, and Dimming at a Specified Rate)
- 8 Open Drain Outputs Capable of Driving up to 25 mA per LED

Typical Application Circuit

DESCRIPTION

LP3944 is an integrated device capable of independently driving 8 LEDs. This device also contains an internal precision oscillator that provides all the necessary timing required for driving each LED. Two prescaler registers along with two PWM registers provide a versatile duty cycle control. The LP3944 contains the ability to dim LEDs in SMBUS/I²C applications where it is required to cut down on bus traffic.

Traditionally, to dim LEDs using a serial shift register such as 74LS594/5 would require a large amount of traffic to be on the serial bus. LP3944 instead requires only the setup of the frequency and duty cycle for each output pin. From then on, only a single command from the host is required to turn each individual open drain output ON, OFF, or to cycle a programmed frequency and duty cycle. Maximum output sink current is 25 mA per pin and 200 mA per package. Any ports not used for controlling the LEDs can be used for general purpose input/output expansion.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet. All trademarks are the property of their respective owners.



LP3944 Pin Out

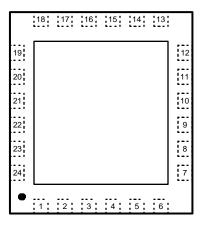


Figure 1. (Top View) Package Number RTW0024A

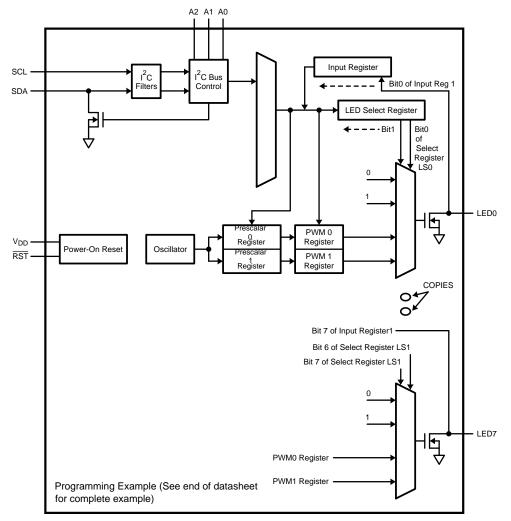
LP3944 PIN DESCRIPTION

| Pin # | Name | Description |
|-------|-----------------|---|
| 1 | LED0 | Output of LED0 Driver |
| 2 | LED1 | Output of LED1 Driver |
| 3 | LED2 | Output of LED2 Driver |
| 4 | LED3 | Output of LED3 Driver |
| 5 | LED4 | Output of LED4 Driver |
| 6 | LED5 | Output of LED5 Driver |
| 7 | LED6 | Output of LED6 Driver |
| 8 | LED7 | Output of LED7 Driver |
| 9 | GND | Ground |
| 10 | NC | No Connect |
| 11 | NC | No Connect |
| 12 | NC | No Connect |
| 13 | NC | No Connect |
| 14 | NC | No Connect |
| 15 | NC | No Connect |
| 16 | NC | No Connect |
| 17 | NC | No Connect |
| 18 | RST | Active Low Reset Input |
| 19 | SCL | Clock Line for I ² C Interface |
| 20 | SDA | Serial Data Line for I ² C Interface |
| 21 | V _{DD} | Power Supply |
| 22 | A0 | Address Input 0 |
| 23 | A1 | Address Input 1 |
| 24 | A2 | Address Input 2 |



SNVS264A-MAY 2004-REVISED APRIL 2013

Architectural Block Diagram



For explanation of LP3944 operation, please refer to Theory of Operation in Application Notes.

Figure 2. Block Diagram



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

SNVS264A - MAY 2004 - REVISED APRIL 2013



Absolute Maximum Ratings⁽¹⁾⁽²⁾⁽³⁾

| V _{DD} | | -0.5V to 6V |
|---|---------------------|-----------------------------|
| A0, A1, A2, SCL, SDA, RST (Collectively called digital pins) | | 6V |
| Voltage on LED pins | | V _{SS} -0.5V to 6V |
| Junction Temperature | | 150°C |
| Storage Temperature | | −65°C to 150°C |
| Power Dissipation ⁽⁴⁾ | | 1.76W |
| | Human Body Model | 2 kV |
| ESD ⁽⁵⁾ | Machine Model | 150V |
| | Charge Device Model | 1 kV |

- (1) Absolute Maximum Ratings are limits beyond which damage to the device may occur. Operating Ratings are conditions under which operation of the device is ensured. Operating Ratings do not imply ensured performance limits. For ensured performance limits and associated test conditions, see the Electrical Characteristics tables.
- (2) All voltages are with respect to the potential at the GND pin.
- (3) If Military/Aerospace specified devices are required, please contact Texas Instruments for availability and specifications.
- (4) The Absolute Maximum power dissipation depends on the ambient temperature and can be calculated using the formulaP = (T_J—T_A)/θ_{JA}, where T_J is the junction temperature, T_A is the ambient temperature, and θ_{JA} is the junction-to-ambient thermal resistance. The 1.76W rating appearing under Absolute Maximum Ratings results from substituting the Absolute Maximum junction temperature, 150°C, for T_J, 85°C for T_A, and 37°C/W for θ_{JA}. More power can be dissipated safely at ambient temperature below 85°C. Less power can be dissipated safely at ambient temperatures above 85°C. The Absolute Maximum power dissipation can be increased by 27 mW for each degree below 85°C, and it must be de-rated by 27 mW for each degree above 85°C. For Operating Ratings maximum power dissipation, T_J = 125°C and T_A = 85°C
- (5) The human-body model is 100 pF discharged through 1.5 k Ω . The machine model is 0 Ω in series with 220 pF.

Operating Ratings⁽¹⁾⁽²⁾

| V _{DD} | | 2.3V to 5.5V | | |
|---------------------------------------|---|--------------|--|--|
| Junction Temperature | lunction Temperature | | | |
| Operating Ambient Temperature | -40°C to +85°C | | | |
| Thermal Resistance (θ _{JA}) | Thermal Resistance (θ_{JA}) WQFN-24 ⁽³⁾ | | | |
| Power Dissipation | | 1.08W | | |

(1) Absolute Maximum Ratings are limits beyond which damage to the device may occur. Operating Ratings are conditions under which operation of the device is ensured. Operating Ratings do not imply ensured performance limits. For ensured performance limits and associated test conditions, see the Electrical Characteristics tables.

(2) All voltages are with respect to the potential at the GND pin.

(3) The Absolute Maximum power dissipation depends on the ambient temperature and can be calculated using the formulaP = (T_J—T_A)/θ_{JA}, where T_J is the junction temperature, T_A is the ambient temperature, and θ_{JA} is the junction-to-ambient thermal resistance. The 1.76W rating appearing under Absolute Maximum Ratings results from substituting the Absolute Maximum junction temperature, 150°C, for T_J, 85°C for T_A, and 37°C/W for θ_{JA}. More power can be dissipated safely at ambient temperature below 85°C. Less power can be dissipated safely at ambient temperatures above 85°C. The Absolute Maximum power dissipation can be increased by 27 mW for each degree below 85°C, and it must be de-rated by 27 mW for each degree above 85°C. For Operating Ratings maximum power dissipation, T_J = 125°C and T_A = 85°C

4

STRUMENTS



Electrical Characteristics

Unless otherwise noted, $V_{DD} = 5.5V$. Typical values and limits appearing in normal type apply for $T_J = 25^{\circ}C$. Limits appearing in **boldface** type apply over the entire junction temperature range for operation, $T_J = -40^{\circ}C$ to $+125^{\circ}C$.⁽¹⁾

| Symbol | Parameter | Conditions | Typical | L | imit | Units |
|-----------------------|---|---|---------|--------------------|--------------------|-------|
| Symbol | rarameter | Conditions | Typical | Min | Max | Onits |
| POWER SI | JPPLY | | | | | |
| V _{DD} | Supply Voltage | | 5 | 2.3 | 5.5 | V |
| Q | Supply Current | No Load | 350 | | 550 | |
| | | Standby | 2.0 | | 5 | μA |
| ΔI _Q | Additional Standby Current | V_{DD} = 5.5V, every LED pin at 4.3V | | | 2 | mA |
| V _{POR} | Power-On Reset Voltage | | 1.8 | | 1.96 | V |
| w | Reset Pulse Width | | 10 | | | ns |
| .ED | | | | | | |
| / _{IL} | LOW Level Input Voltage | | | -0.5 | 0.8 | V |
| / _{IH} | HIGH Level Input Voltage | | | 2.0 | 5.5 | V |
| OL | Low Level Output Current ⁽²⁾ | $V_{OL} = 0.4V, V_{DD} = 2.3V$ | | 9 | | |
| | | $V_{OL} = 0.4V, V_{DD} = 3.0V$ | | 12 | | |
| | | $V_{OL} = 0.4V, V_{DD} = 5.0V$ | | 15 | | mA |
| | | $V_{OL} = 0.7V, V_{DD} = 2.3V$ | | 15 | | IIIA |
| | | $V_{OL} = 0.7V, V_{DD} = 3.0V$ | | 20 | | |
| | | $V_{OL} = 0.7V, V_{DD} = 5.0V$ | | 25 | | |
| LEAK | Input Leakage Current | V_{DD} = 3.6, V_{IN} = 0V or V_{DD} | | -1 | 1 | μA |
| C _{I/O} | Input/Output Capacitance | See ⁽³⁾ | 2.6 | | 5 | pF |
| ALL DIGIT | AL PINS (EXCEPT SCL AND SDA | PINS) | | · | | |
| / _{IL} | LOW Level Input Voltage | | | -0.5 | 0.8 | V |
| / _{IH} | HIGH Level Input Voltage | | | 2.0 | 5.5 | V |
| LEAK | Input Leakage Current | | | -1 | 1 | μA |
| C _{IN} | Input Capacitance | $V_{IN} = 0V^{(3)}$ | 2.3 | | 5 | pF |
| ² C INTERF | FACE (SCL AND SDA PINS) | | | | | |
| / _{IL} | LOW Level Input Voltage | | | -0.5 | 0.3V _{DD} | V |
| / _{IH} | HIGH Level Input Voltage | | | 0.7V _{DD} | 5.5 | V |
| / _{OL} | LOW Level Output Voltage | | | 0 | 0.2V _{DD} | V |
| OL | LOW Level Output Current | $V_{OL} = 0.4 V$ | 6.5 | 3 | | mA |
| CLK | Clock Frequency | See ⁽³⁾ | | | 400 | kHz |
| HOLD | Hold Time Repeated START Condition | See ⁽³⁾ | | 0.6 | | μs |
| CLK-LP | CLK Low Period | See ⁽³⁾ | | 1.3 | | μs |
| CLK-HP | CLK High Period | See ⁽³⁾ | | 0.6 | | μs |
| SU | Set-Up Time Repeated START Condition | See ⁽³⁾ | | 0.6 | | μs |
| DATA-HOLD | Data Hold Time | See ⁽³⁾ | | 300 | | ns |
| DATA-SU | Data Set-Up Time | See ⁽³⁾ | | 100 | | ns |
| SU | Set-Up Time for STOP Condition | See ⁽³⁾ | | 0.6 | | μs |
| TRANS | Maximum Pulse Width of Spikes that Must Be Suppressed by the Input Filter of Both DATA & CLK Signals | See ⁽³⁾ | 50 | | | ns |

(1) Limits are ensured. All electrical characteristics having room-temperature limits are tested during production with T_J = 25°C. All hot and cold limits are ensured by correlating the electrical characteristics to process and temperature variations and applying statistical process control.

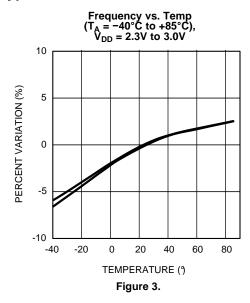
(2) Each LED pin should not exceed 25 mA and the package should not exceed a total of 200 mA.

(3) Ensured by design.



SNVS264A - MAY 2004 - REVISED APRIL 2013

Typical Performance Characteristics





APPLICATION INFORMATION

Theory of Operation

The LP3944 takes incoming data and feed them into several registers that control the frequency and the duty cycle of the LEDs. Two prescaler registers and two PWM registers provide two individual rates to dim or blink the LEDs (for more information on these registers, refer to Table 1). The baseband controller/microprocessor can program each LED to be in one of four states—on, off, DIM0 rate or DIM1 rate. One read-only registers provide status on all 8 LEDs. The LP3944 can be used to drive RGB LEDs and/or single-color LEDs to create a colorful, entertaining, and informative setting. This is particularly suitable for accessory functions in cellular phones and toys. Any LED pins not used to drive LED can be used for General Purpose Parallel Input/Output (GPIO) expansion.

The LP3944 is equipped with Power-On Reset that holds the chip in a reset state until V_{DD} reaches V_{POR} during power up. Once V_{POR} is achieved, the LP3944 comes out of reset and initializes itself to the default state.

To bring the LP3944 into reset, hold the \overline{RST} pin LOW for a period of TW. This will put the chip to its default state. The LP3944 can only be programmed after \overline{RST} signal is HIGH again.

I²C Data Validity

The data on SDA line must be stable during the HIGH period of the clock signal (SCL). In other words, state of the data line can only be changed when CLK is LOW.

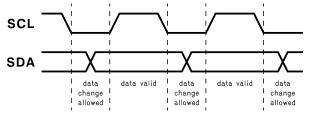


Figure 4. I²C Data Validity

I²C Start and Stop Conditions

START and STOP bits classify the beginning and the end of the I²C session. START condition is defined as SDA signal transitioning from HIGH to LOW while SCL line is HIGH. STOP condition is defined as the SDA transitioning from LOW to HIGH while SCL is HIGH. The I²C master always generates START and STOP bits. The I²C bus is considered to be busy after START condition and free after STOP condition. During data transmission, I²C master can generate repeated START conditions. First START and repeated START conditions are equivalent, function-wise.

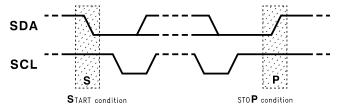


Figure 5. I²C START and STOP Conditions

Transferring Data

Every byte put on the SDA line must be eight bits long with the most significant bit (MSB) being transferred first. The number of bytes that can be transmitted per transfer is unrestricted. Each byte of data has to be followed by an acknowledge bit. The acknowledge related clock pulse is generated by the master. The transmitter releases the SDA line (HIGH) during the acknowledge clock pulse. The receiver must pull down the SDA line during the 9th clock pulse, signifying an acknowledge. A receiver which has been addressed must generate an acknowledge after each byte has been received.

Copyright © 2004–2013, Texas Instruments Incorporated

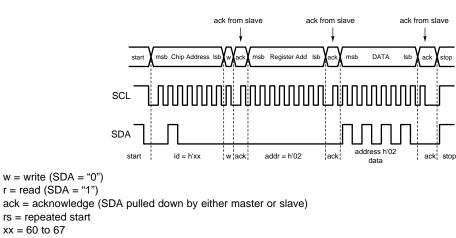


SNVS264A - MAY 2004 - REVISED APRIL 2013

After the START condition, a chip address is sent by the I²C master. This address is seven bits long followed by an eighth bit which is a data direction bit (R/W). The LP3944 hardwires bits 7 to 4 and leaves bits 3 to 1 selectable, as shown in Figure 6. For the eighth bit, a "0" indicates a WRITE and a "1" indicates a READ. The LP3944 supports only a WRITE during chip addressing. The second byte selects the register to which the data will be written. The third byte contains data to write to the selected register.

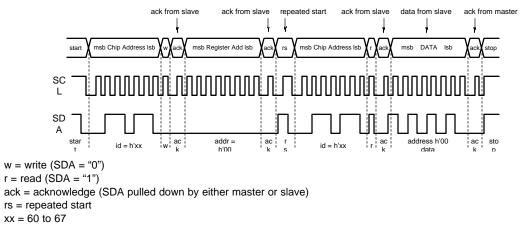








However, if a READ function is to be accomplished, a WRITE function must precede the READ function, as shown in Figure 8.





Auto Increment

Auto increment is a special feature supported by the LP3944 to eliminate repeated chip and register addressing when data are to be written to or read from registers in sequential order. The auto increment bit is inside the register address byte, as shown in Figure 9. Auto increment is enabled when this bit is programmed to "1" and disabled when it is programmed to "0".



SNVS264A - MAY 2004 - REVISED APRIL 2013

www.ti.com

| MSB | | | | - | | | LSB | | | |
|---------------|---|---------------|-------|---------------|---------------|---------------|---------------|--|--|--|
| reg addr_7 | reg addr_6 | reg addr_5 | AI | reg addr_3 | reg addr_2 | reg addr_1 | reg addr_0 | | | |
| bit_7 | bit_6 | bit_5 | bit_4 | bit_3 | bit_2 | bit_1 | bit_0 | | | |
| 1 | 1 2 3 4 5 6 7 8 | | | | | | | | | |
| | I ² C SLAVE register address | | | | | | | | | |

Figure 9. Register Address Byte

In the READ mode, when auto increment is enabled, I²C master could receive any number of bytes from LP3944 without selecting chip address and register address again. Every time the I²C master reads a register, the LP3944 will increment the register address and the next data register will be read. When I²C master reaches the last register (09H register), the register address will roll over to 00H.

In the WRITE mode, when auto increment is enabled, the LP3944 will increment the register address every time I²C master writes to register. When the last register (09H register) is reached, the register address will roll over to 02H, because the first two registers in LP3944 are read-only registers. It is possible to write to these two registers, and the LP3944 will acknowledge, but the data will be ignored.

In the LP3944, registers 0x01, 0x08 and 0x09 are not functional. However, it is still necessary to read from 0x01 and to write to 0x08 and 0x09 in Auto Increment mode. They cannot be skipped.

If auto increment is disabled, and the I²C master does not change register address, it will continue to write data into the same register.

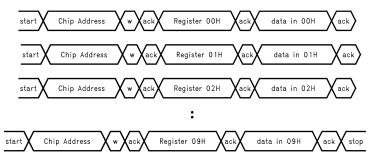


Figure 10. Programming with Auto Increment Disabled (in WRITE Mode)



Figure 11. Programming with Auto Increment Enabled (in WRITE Mode)

SNVS264A - MAY 2004 - REVISED APRIL 2013

www.ti.com

Table 1. LP3944 Register Table⁽¹⁾

| | | 0 | |
|---------------|---------------|------------|-----------------------|
| Address (Hex) | Register Name | Read/Write | Register Function |
| 0x00 | Input 1 | Read Only | LED0-7 Input Register |
| 0x01 | Register 1 | Read Only | None |
| 0x02 | PSC0 | R/W | Frequency Prescaler 0 |
| 0x03 | PWM0 | R/W | PWM Register 0 |
| 0x04 | PSC1 | R/W | Frequency Prescaler 1 |
| 0x05 | PWM1 | R/W | PWM Register 1 |
| 0x06 | LS0 | R/W | LED0–3 Selector |
| 0x07 | LS1 | R/W | LED4–7 Selector |
| 0x08 | Register 8 | R/W | None |
| 0x09 | Register 9 | R/W | None |

(1) Note: Registers 1, 8 and 9 are empty and non-functional registers. Register 1 is read-only, with all bits hard-wired to zero. Registers 8 and 9 can be written and read, but the content does ot have any effect on the operation of the LP3944.

Binary Fomat for Input Registers (Read Only)—Address 0x00 and 0x01

| Bit # | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|------|------|------|------|------|------|------|
| Default value | Х | Х | Х | Х | Х | Х | Х | Х |
| | LED7 | LED6 | LED5 | LED4 | LED3 | LED2 | LED1 | LED0 |

Table 2. Address 0x00⁽¹⁾

(1) X = don't care

Binary Format for Frequency Prescaler and PWM Registers — Address 0x02 to 0x05

Table 3. Address 0x02 (PSC0)⁽¹⁾

| Bit # | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|---|---|---|---|
| Default value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

 PSC0 register is used to program the period of DIM0. DIM0 = (PSC0+1)/160 The maximum period is 1.6s when PSC0 = 255.

Table 4. Address 0x03 (PWM0)⁽¹⁾

| Bit # | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|---|---|---|---|
| Default value | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

(1) PWM0 register determines the duty cycle of DIM0. The LED outputs are LOW (LED on) when the count is less than the value in PWM0 and HIGH (LED off) when it is greater. If PWM0 is programmed with 0x00, LED output is always HIGH (LED off).

The duty cycle of DIM0 is: PWM0/256 Default value is 50% duty cycle.

Table 5. Address 0x04 (PSC1)⁽¹⁾

| Bit # | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|---|---|---|---|
| Default value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

 PSC1 register is used to program the period of DIM1. DIM1 = (PSC1 + 1)/160 The maximum period is 1.6s when PSC1 = 255.



Table 6. Address 0x05 (PWM1)⁽¹⁾

| Bit # | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|---|---|---|---|---|---|---|---|
| Default value | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

(1) PWM1 register determines the duty cycle of DIM1. The LED outputs are LOW (LED on) when the count is less than the value in PWM1 and HIGH (LED off) when it is greater. If PWM1 is programmed with 0x00, LED output is always HIGH (LED off).

The duty cycle of DIM1 is: PWM1/256 Default value is 50% duty cycle.

Binary Format for Selector Registers — Address 0x06 to 0x07Table 7

Table 7. Address 0x06 (LS0)

| Bit # | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|------|----|------|----|------|----|------|----|
| Default value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | B1 | B0 | B1 | B0 | B1 | B0 | B1 | B0 |
| | LED3 | | LED2 | | LED1 | | LED0 | |

Table 8. Address 0x07 (LS1)

| Bit # | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
|---------------|------|----|------|----|----|----|------|----|--|
| Default value | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | |
| | B1 | B0 | B1 | B0 | B1 | B0 | B1 | B0 | |
| | LED7 | | LED6 | | LE | D5 | LED4 | | |

Table 9. LED States With Respect To Values in "B1" and "B0"

| B1 | B0 | Function |
|----|----|----------------------------|
| 0 | 0 | Output Hi-Z (LED off) |
| 0 | 1 | Output LOW (LED on) |
| 1 | 0 | Output dims (DIM0 rate) |
| 1 | 1 | Output dims (DIM1 rate) |

Programming Example:

Dim LEDs 0 to 7 at 1 Hz at 25% duty cycle

- 1. Set PSC0 to achieve DIM0 of 1s
- 2. Set PWM0 duty cycle to 25%
- 3. Set PSC1 to achieve DIM1 of 0.2s
- 4. Set LEDs 0 to 7 to point to DIM0

| Step | Description | Register Name | Set to (Hex) |
|------|---|---------------|--------------------------|
| 1 | Set DIM0 = 1s 1 = (PSC0 + 1)/160 PSC0 = 159 | PSC0 | 0x09F |
| 2 | Set duty cycle to 25% Duty Cycle = PWM0/256 PWM0 = 64 | PWM0 | 0x40 |
| 3 | Set DIM1 = 0.2s 0.2 = (PSC1 + 1)/160 PSC1 = 31 | PSC1 | 0x1F |
| 4 | LEDs 0 to 7 Output = DIM0 | LS0, LS1 | LS0 = 0xAA LS1 = 0xAA |



SNVS264A - MAY 2004 - REVISED APRIL 2013

Reducing $I_{\mbox{\scriptsize Q}}$ When LEDs are Off

In many applications, the LEDs and the LP3944 share the same V_{DD}, as shown in Typical Application Circuit. When the LEDs are off, the LED pins are at a lower potential than V_{DD}, causing extra supply current (ΔI_Q). To minimize this current, consider keeping the LED pins at a voltage equal to or greater than V_{DD}.

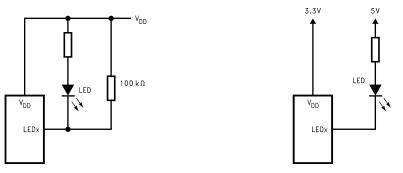


Figure 12. Methods to Reduce ${\rm I}_{\rm Q}$ When LEDs Are Off

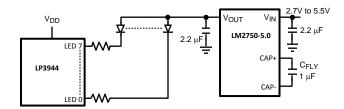


Figure 13. Application Circuit

SNVS264A-MAY 2004-REVISED APRIL 2013

| Cł | nanges from Original (April 2013) to Revision A | Page |
|----|--|------|
| • | Changed layout of National Data Sheet to TI format | 12 |



10-Dec-2020

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|---------|
| LP3944ISQ/NOPB | ACTIVE | WQFN | RTW | 24 | 1000 | RoHS & Green | SN | Level-3-260C-168 HR | -40 to 85 | 3944SQ | Samples |
| LP3944ISQX/NOPB | ACTIVE | WQFN | RTW | 24 | 4500 | RoHS & Green | SN | Level-3-260C-168 HR | -40 to 85 | 3944SQ | Samples |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <= 1000ppm threshold. Antimony trioxide based flame retardants must also meet the <= 1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer:The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.



PACKAGE OPTION ADDENDUM

10-Dec-2020

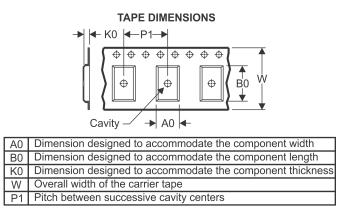
PACKAGE MATERIALS INFORMATION

Texas Instruments

www.ti.com

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

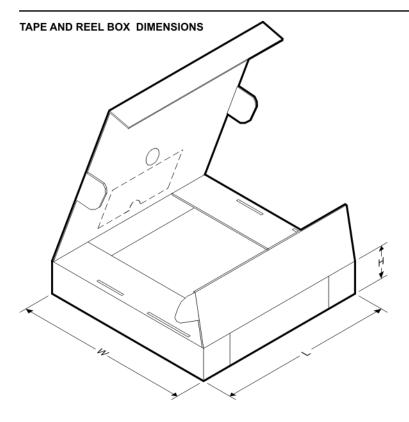


| *All dimensions are nominal | | | | | | | | | | | | |
|-----------------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
| LP3944ISQ/NOPB | WQFN | RTW | 24 | 1000 | 178.0 | 12.4 | 4.3 | 4.3 | 1.3 | 8.0 | 12.0 | Q1 |
| LP3944ISQX/NOPB | WQFN | RTW | 24 | 4500 | 330.0 | 12.4 | 4.3 | 4.3 | 1.3 | 8.0 | 12.0 | Q1 |



PACKAGE MATERIALS INFORMATION

9-Apr-2022



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| LP3944ISQ/NOPB | WQFN | RTW | 24 | 1000 | 208.0 | 191.0 | 35.0 |
| LP3944ISQX/NOPB | WQFN | RTW | 24 | 4500 | 356.0 | 356.0 | 35.0 |

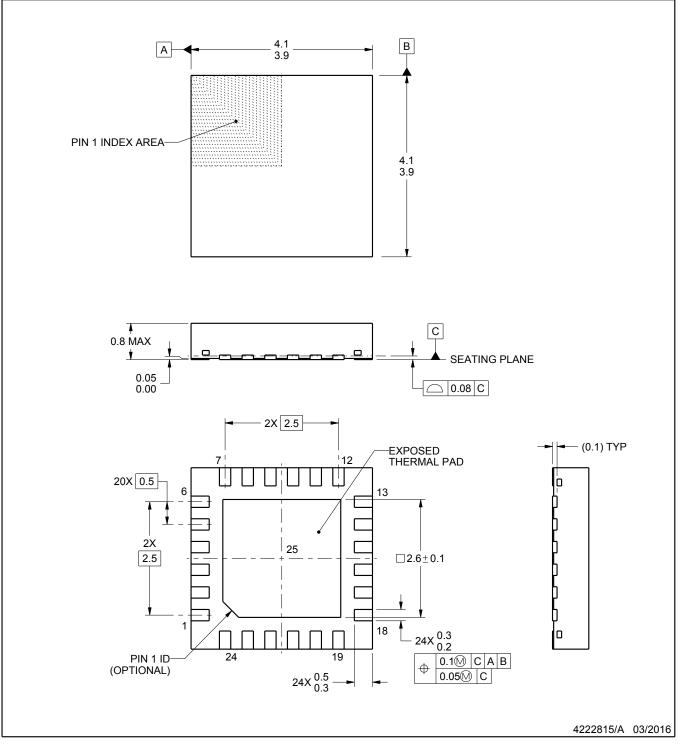
RTW0024A



PACKAGE OUTLINE

WQFN - 0.8 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice.
- 3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

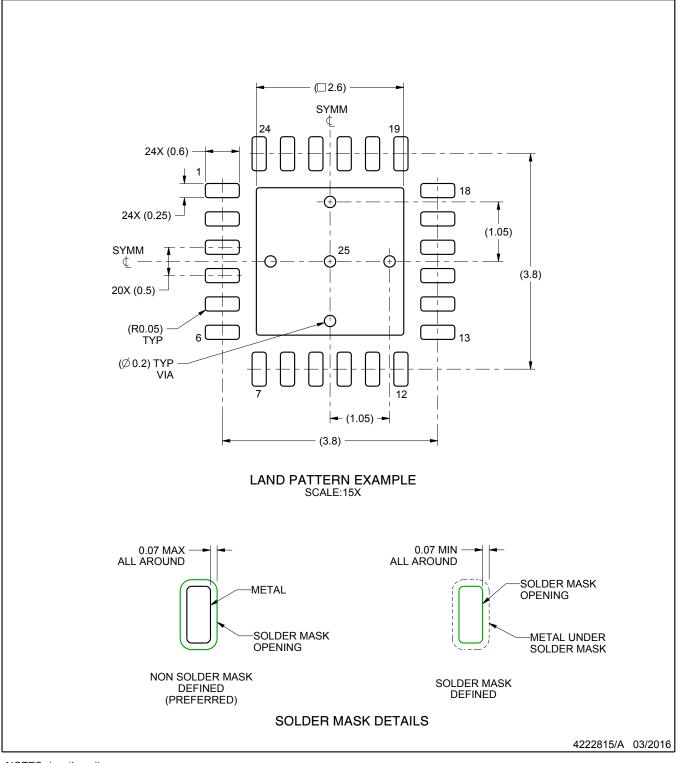


RTW0024A

EXAMPLE BOARD LAYOUT

WQFN - 0.8 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).

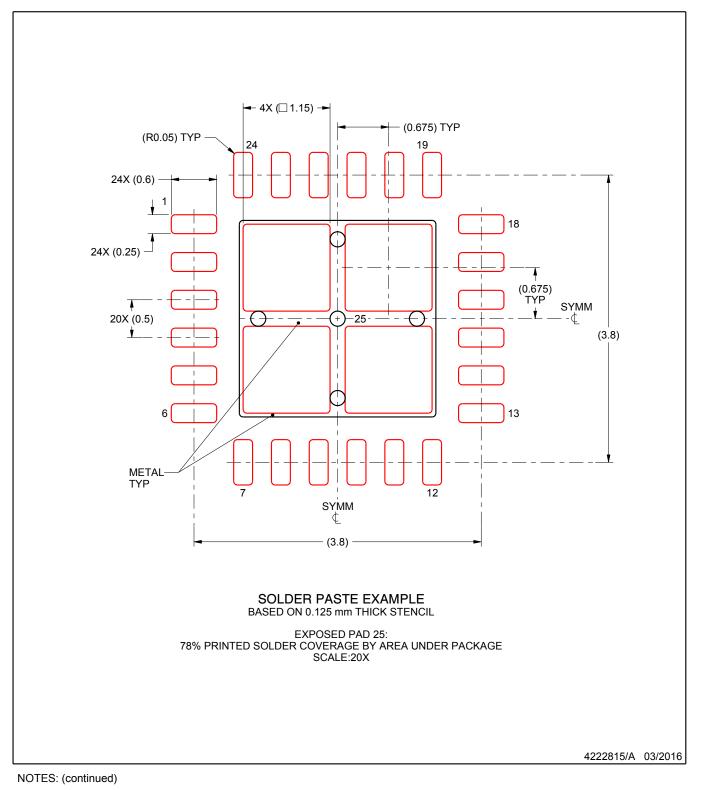


RTW0024A

EXAMPLE STENCIL DESIGN

WQFN - 0.8 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2022, Texas Instruments Incorporated